



Docket No. 618902001410  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Chun H. FAN et al.

Application No. 10/681,983

Confirmation No. 8846

Filed: October 9, 2003

Art Unit: 2826

For: MULTIPLE LEADFRAME LAMINATED IC  
PACKAGE

Examiner: Leonardo Andujar

**RESPONSE UNDER 37 CFR 1.111**

MS Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Action dated November 22, 2006, please reconsider this application in light of the following remarks.

**REMARKS**

Initially, applicants note that the Office Action Summary does not correctly reflect the contents of the Action. Specifically, the Summary identifies claims 15 and 16 as objected to, which they are not. Furthermore, the Summary fails to indicate that claims 12 and 15 are allowed, while claims 13 and 14 are objected to. Applicants assume that the inconsistencies are merely the result of typographical errors.

Applicants thank the Examiner for indicating that claims 12 and 15 are allowable, and that claims 13 and 14 contain allowable subject matter. Applicants have respectfully maintained claims 13 and 14 in their dependent form in light of the following remarks.